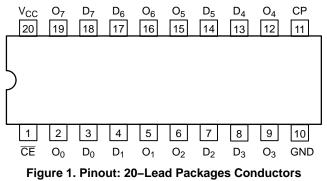
Octal D Flip-Flop with Clock Enable

The MC74AC377/74ACT377 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) input loads all flip-flops simultaneously, when the Clock Enable (\overline{CE}) is LOW. The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output. The \overline{CE} input must be stable only one setup time prior to the LOW-to-HIGH clock transition for predictable operation.

Features

- Ideal for Addressable Register Applications
- Clock Enable for Address and Data Synchronization Applications
- Eight Edge-Triggered D Flip-Flops
- Buffered Common Clock
- Outputs Source/Sink 24 mA
- See MC74AC273 for Master Reset Version
- See MC74AC373 for Transparent Latch Version
- See MC74AC374 for 3-State Version
- ACT377 Has TTL Compatible Inputs
- MSL = 1 for all Surface Mount
- Chip Complexity: 292 FETs or 73 Gates
- These are Pb–Free Devices



(Top View)

PIN NAMES

PIN	FUNCTION
D ₀ -D ₇	Data Inputs
CE	Clock Enable (Active LOW)
Q ₀ -Q ₇	Data Outputs
СР	Clock Pulse Input

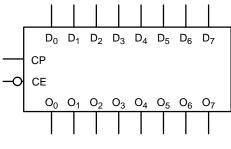


Figure 2. Logic Symbol



ON Semiconductor®

www.onsemi.com



SOIC-20W DW SUFFIX CASE 751D



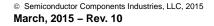
TSSOP-20 DT SUFFIX CASE 948E

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 7 of this data sheet.



MODE SELECT-FUNCTION TABLE

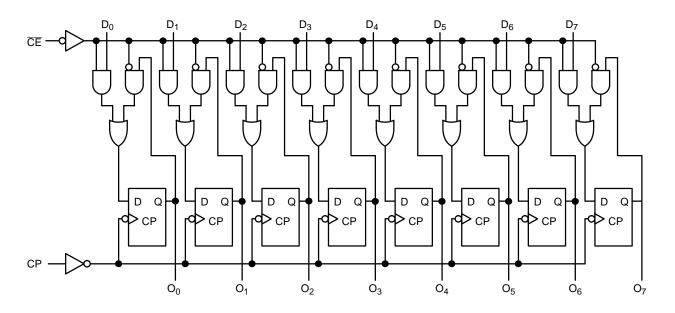
On creating a Marda		Inputs	Outputs		
Operating Mode	СР	CE	D _n	Q _n	
Load '1'	г	L	Н	Н	
Load '0'	L	L	L	L	
	L	Н	Х	No Change	
Hold (Do Nothing)	х	н	Х	No Change	

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

_ = LOW-to-HIGH Clock Transition



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

MAXIMUM RATINGS

Symbol	Paran	neter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)		-0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)		–0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage (Referenced to GND)	(Note 1)	–0.5 to V _{CC} +0.5	V
I _{IK}	DC Input Diode Current		±20	mA
I _{OK}	DC Output Diode Current		±50	mA
I _{OUT}	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current, per Output Pin		±50	mA
I _{GND}	DC Ground Current, per Output Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead temperature, 1 mm from Case for 10) Seconds	260	°C
Τ _J	Junction Temperature Under Bias		140	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	65.8 110.7	°C/W
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V–0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage	Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	> 2000 > 200 > 1000	V
I _{Latchup}	Latchup Performance Abo	ve V _{CC} and Below GND at 85° C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

I_{OUT} absolute maximum rating must be observed.
The package thermal impedance is calculated in accordance with JESD 51–7.

3. Tested to EIA/JESD22-A114-A.

4. Tested to EIA/JESD22-A115-A.

Tested to JESD22-C101-A. 5.

6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Тур	Max	Unit
	Oursels Mallane	′AC	2.0	5.0	6.0	
V _{CC}	Supply Voltage	′ACT	4.5	5.0	5.5	V
$V_{\text{in}}, V_{\text{out}}$	DC Input Voltage, Output Voltage (Ref. to GND)	·	0	-	V _{CC}	V
			_	150	-	
t _r , t _f	t _r , t _f Input Rise and Fall Time (Note 7) 'AC Devices except Schmitt Inputs	V _{CC} @ 4.5 V	-	40	-	ns/V
		V _{CC} @ 5.5 V	-	25	-	
	Input Rise and Fall Time (Note 8)	V _{CC} @ 4.5 V	-	10	-	ns/V
t _r , t _f	'ACT Devices except Schmitt Inputs	V _{CC} @ 5.5 V	-	8.0	-	ns/v
T _A	Operating Ambient Temperature Range		-40	25	85	°C
I _{OH}	Output Current – High	-	-	-24	mA	
I _{OL}	Output Current – Low	_	-	24	mA	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 7. V_{in} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 8. V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

74AC – DC CHARACTERISTICS

Symbol	Parameter	V _{CC}	T _A = -	⊦25°C	T _A = –40°C to +85°C	Unit	Conditions	
		(V)	Тур	Gua	ranteed Limits			
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.50 2.25 2.75	2.10 3.15 3.85	2.10 3.15 3.85	V V V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$	
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.50 2.25 2.75	0.90 1.35 1.65	0.90 1.35 1.65	V V V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$	
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V V V	I _{OUT} = -50 μA	
		3.0 4.5 5.5	-	2.56 3.86 4.86	2.46 3.76 4.76	V V V	$\label{eq:VIN} \begin{array}{cc} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} & -12 \text{ mA} \\ I_{OH} & -24 \text{ mA} \\ & -24 \text{ mA} \end{array}$	
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V V V	I _{OUT} = 50 μA	
		3.0 4.5 5.5	-	0.36 0.36 0.36	0.44 0.44 0.44	V V V	$\label{eq:VIN} \begin{array}{cc} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} & -12 \text{ mA} \\ I_{OH} & -24 \text{ mA} \\ & -24 \text{ mA} \end{array}$	
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$	
I _{OLD} I _{OHD}	Maximum Input Leakage Current	5.5 5.5	-	-	75 –75	mA mA	V _{OLD} = 1.65 V Max V _{OHD} = 3.85 V Min	
I _{CC}	Maximum Quiescent Supply Current	5.5	-	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND	

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time. NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

74AC – AC CHARACTERISTICS For Figures and Waveforms, See Figures 4, 5, and 6.

Symbol	ymbol Parameter		V _{CC} *	T _A = +	25°C C _L =	50 pF	$T_{A} = -40^{\circ}C_{L} = 0$	C to +85°C 50 pF	Unit
			(V)	Min	Тур	Max	Min	Мах	
f _{max}	Maximum Clock Frequency		3.3 5.0	90 140	-	-	75 125	-	MHz
t _{PLH}	Propagation Delay	$CP \text{ to } Q_{n}$	3.3 5.0	3.0 2.0	-	13.0 9.0	1.5 1.5	14.0 10.0	ns
t _{PHL}	Propagation Delay	$CP \text{ to } Q_{n}$	3.3 5.0	3.5 2.5	-	13.0 10.0	2.0 1.5	14.5 11.0	ns

* Voltage Range 3.3 V is 3.3 V ± 0.3 V; Voltage Range 5.0 V is 5.0 V ± 0.5 V.

74AC – AC OPERATING REQUIREMENTS

Cumhal	Denemeter		V _{CC} *	T _A =	+25°C C _L = 50 pF	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	11	
Symbol	Parameter	Parameter		Parameter V _{CC} * (V) Ty		Тур	Guarantee	Unit
t _s	Setup Time, HIGH or LOW	D _n to CP	3.3 5.0	-	5.5 4.07	6.0 4.5	ns	
t _h	Hold Time, HIGH or LOW	D _n to CP	3.3 5.0	-	0 1.0	0 1.0	ns	
ts	Setup Time, HIGH or LOW	CE to CP	3.3 5.0	-	6.0 4.0	7.5 4.5	ns	
t _h	Hold Time, HIGH or LOW	CE to CP	3.3 5.0	-	0 1.0	0 1.0	ns	
t _w	CP Pulse Width	HIGH or LOW	3.3 5.0	_	5.5 4.0	6.0 4.5	ns	

* Voltage Range 3.3 V is 3.3 V \pm 0.3 V; Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

74ACT – DC CHARACTERISTICS

Symbol	Parameter	V _{CC}	T _A = -	⊦25°C	T _A = –40°C to +85°C	Unit	Conditions
-		(V)	Тур	Gua	ranteed Limits		
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA
		4.5 5.5	-	3.86 4.86	3.76 4.76	V	$\label{eq:VIN} \begin{array}{ll} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} & -24 \text{ mA} \\ I_{OH} & -24 \text{ mA} \end{array}$
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5	-	0.36 0.36	0.44 0.44	V	$\label{eq:VIN} \begin{array}{ll} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} & -24 \text{ mA} \\ I_{OH} & -24 \text{ mA} \end{array}$
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
ΔI_{CCT}	Additional Max I _{CC} /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 V$
I _{OLD} I _{OHD}	†Minimum Dynamic Output Current	5.5	-	-	75 –75	mA	V_{OLD} = 1.65 V Max V_{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	-	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

74ACT - AC CHARACTERISTICS For Figures and Waveforms — See Figures 4, 5, and 6.

Symbol	Parameter	er		T _A = +2	25°C C _L =	50 pF	$T_{A} = -40^{\circ}C_{L}$	C to +85°C 50 pF	Unit
-			(V)	Min	Тур	Мах	Min	Max	
f _{max}	Maximum Clock Frequency		5.0	140	-	-	125	-	MHz
t _{PLH}	Propagation Delay	CP to Q _n	5.0	3.0	-	9.0	2.5	10	ns
t _{PHL}	Propagation Delay 0	CP to Q _n	5.0	3.5	-	10	2.5	11	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

74ACT – AC OPERATING REQUIREMENTS

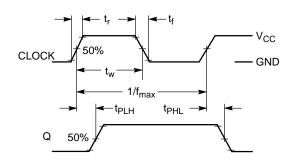
Symbol	Parameter		T _A =	+25°C C _L = 50 pF	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ $C_L = 50 \text{ pF}$	Unit
		(V)	Тур	Guarantee	d Minimum	
t _s	Setup Time, HIGH or LOW D _n to CP	5.0	-	4.5	5.5	ns
t _h	Hold Time, HIGH or LOW D _n to CP	5.0	-	1.0	1.0	ns
t _s	Setup Time, HIGH or LOW CE to CP	5.0	-	4.5	5.5	ns
t _h	Hold Time, HIGH or LOW CE to CP	5.0	-	1.0	1.0	ns
t _w	CP Pulse Width HIGH or LOW	5.0	-	4.0	4.5	ns

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0 V$
C _{PD}	Power Dissipation Capacitance	90	pF	$V_{CC} = 5.0 V$

SWITCHING WAVEFORMS



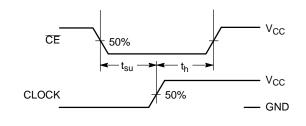
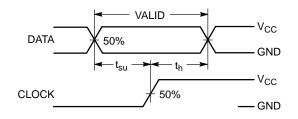
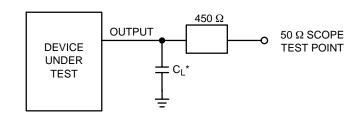


Figure 4.









*Includes all probe and jig capacitance

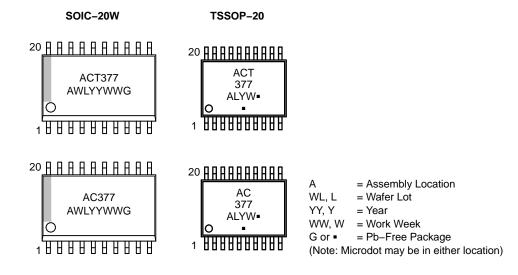
Figure 7. Test Circuit

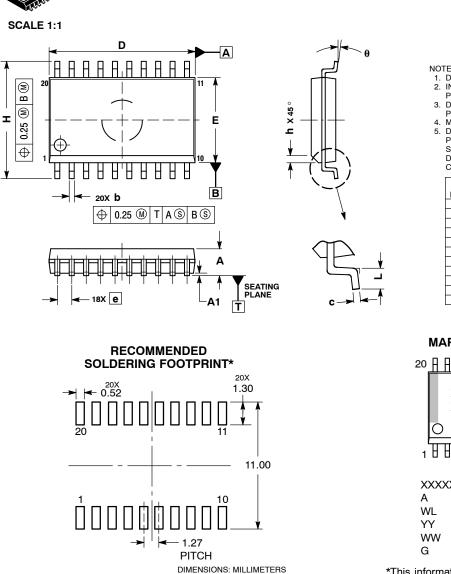
ORDERING INFORMATION

Device	Package	Shipping [†]
MC74AC377DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC377DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT377DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT377DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74AC377DTG	TSSOP-20 (Pb-Free)	75 Units / Rail
MC74AC377DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MARKING DIAGRAMS





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 22 APR 2015

DUSEM

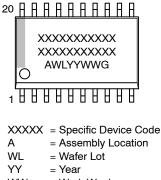
NOTES:

SOIC-20 WB CASE 751D-05 ISSUE H

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		
DIM	MIN	MAX	
Α	2.35	2.65	
A1	0.10	0.25	
b	0.35	0.49	
C	0.23	0.32	
D	12.65	12.95	
Е	7.40	7.60	
е	1.27 BSC		
Н	10.05	10.55	
h	0.25	0.75	
L	0.50	0.90	
θ	0 °	7 °	

GENERIC **MARKING DIAGRAM***



= Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98ASB42343B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	SOIC-20 WB		PAGE 1 OF 1		
onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi ansume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.					





DOCUMENT NUMBER:	98ASH70169A	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TSSOP-20 WB		PAGE 1 OF 1

ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the right or others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative